FM0+ Family S6E1A1 Series, Flash Programming Guide

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Preface

Purpose of this manual and intended readers

This manual explains the functions, operations and serial programming of the flash memory of this series. This manual is intended for engineers engaged in the actual development of products using this series.

Trademark

ARM and Cortex-M0+ are the trademarks of ARM Limited in the EU and other countries.

The company names and brand names herein are the trademarks or registered trademarks of their respective owners.

Organization of this Manual

This manual consists of the following 3 chapters.

- CHAPTER 1 Flash Memory

  This chapter gives an overview of, and explains the structure, operation, and registers of the Main Flash memory.

- CHAPTER 2 Flash Security

  The flash security feature provides possibilities to protect the content of the flash memory. This chapter section describes the overview and operations of the flash security.

- CHAPTER 3 Serial Programming Connection

  This chapter explains the basic configuration for serial write to flash memory by using the Fujitsu Semiconductor Serial Programmer.

Sample programs and development environment

Cypress offers sample programs free of charge for operating the peripheral functions of the FM0+ family. Cypress also makes available descriptions of the development environment required for this series. Feel free to use them to verify the operational specifications and usage of this Fujitsu Semiconductor microcontroller.

Microcontroller support information:

http://www.cypress.com/cypress-microcontrollers

Note:

- Note that the sample programs are subject to change without notice. Since they are offered as a way to demonstrate standard operations and usage, evaluate them sufficiently before running them on your system. Cypress assumes no responsibility for any damage that may occur as a result of using a sample program.

How to Use This Manual

Searching for a function

The following methods can be used to search for the explanation of a desired function in this manual:

- Search from the table of the contents

  The table of the contents lists the manual contents in the order of description.

- Search from the register

  The address where each register is located is not described in the text. To verify the address of a register, see "APPENDIXES A. Register Map" of "FM0+ Peripheral Manual".

Terminology

This manual uses the following terminology.

Term	Explanation
Word	Indicates access in units of 32 bits.
Half word	Indicates access in units of 16 bits.
Byte	Indicates access in units of 8 bits.

Notations

- The notations in bit configuration of the register explanation of this manual are written as follows.
  - ☐ bit : bit number
  - ☐ Field: bit field name
  - ☐ Attribute : Attributes for read and write of each bit
  - ☐ R : Read only
  - ☐ W : Write only
  - ☐ R/W : Readable/Writable
  - ☐ - : Undefined
  - ☐ Initial value : Initial value of the register after reset
  - ☐ 0 : Initial value is "0"
  - ☐ 1 : Initial value is "1"
  - ☐ X : Initial value is undefined

- The multiple bits are written as follows in this manual.
  Example : bit7:0 indicates the bits from bit7 to bit0

- The values such as for addresses are written as follows in this manual.
  - ☐ Hexadecimal number : "0x" is attached in the beginning of a value as a prefix (example : 0xFFFF)
  - ☐ Binary number: "0b" is attached in the beginning of a value as a prefix (example: 0b1111)
  - ☐ Decimal number: Written using numbers only (example : 1000)

Table 1. Applicable Products (FM0+ TYPE1 product list)

Type name*	Flash memory size	
	88 Kbyte	56 Kbyte
TYPE1	S6E1A12B0A S6E1A12C0A	S6E1A11B0A S6E1A11C0A

* : These type names are used to group applicable products in FM0+ Family peripheral manual.

Contents

1. Flash Memory

This chapter explains the overview, configuration, operation, and registers of the Flash memory.

This series is equipped with the Flash Memory of up to 88 Kbyte for which Flash erase (simultaneous data erase of all sectors), data erase of each sector, and data write with CPU can be implemented.

1.1 Overview

This series is equipped with up to 88 Kbyte Flash Memory.
The built-in Flash Memory could erase data by-sector, or erase flash (erase data by-all-sector collectively), and write programmed data by byte (8 bits) or by half-word (16 bits) with the Cortex-M0+ CPU.

Flash memory features

- Usable capacity: Up to 88 Kbyte
- Detection of write/erase completion with CPU interrupt
- High-speed flash memory:
  Up to 40 MHz: 0Wait

- Operating mode:

1. CPU mode

   This mode allows reading, writing, and erasing of flash memory from CPU (automatic algorithm*). The operation of writing data by byte (8 bits) or by half word (16 bits) is available.
   To rewrite data, execute a program on RAM.

2. ROM writer mode

   This mode allows reading, writing, and erasing of flash memory from a ROM writer (automatic algorithm*).

- Built-in flash security function
  (Prevents reading of the content of flash memory by a third party)
  See "CHAPTER Flash Security" for details on the flash security function.

Note:

- This document explains the usage of flash memory in CPU mode.
  For details on accessing the flash memory from a ROM writer, see the instruction manual of the ROM writer that is being used.

*: Automatic algorithm = Embedded Algorithm

1.2 Configuration

This series consists of 56 Kbyte to 88 Kbyte Flash memory area, a security code area, and a CR trimming data area.

Table 1-1 shows the correspondence between Capacity of Flash Memory built into this series and Product TYPE. Figure 1-1 to Figure 1-4 show the address and sector structure of the Main Flash memory built into this series as well as the address of security/CR trimming data.

See "CHAPTER Flash Security" for details on the security.

See section "1.4.6 CR Trimming Data Mirror Register (CRTRMM)" and chapter "High-Speed CR Trimming" in the "FM0+ Family Peripheral Manual" for details on the High-Speed CR trimming data.

Table 1-1. Flash Memory Capacity by FM0+ Product TYPE

Product TYPE	Flash Memory Capacity	
	88 Kbyte	56 Kbyte
TYPE1	S6E1A12B0A S6E1A12C0A	S6E1A11B0A S6E1A11C0A

Figure 1-1. Address and sector structure of 88 Kbyte Flash Memory

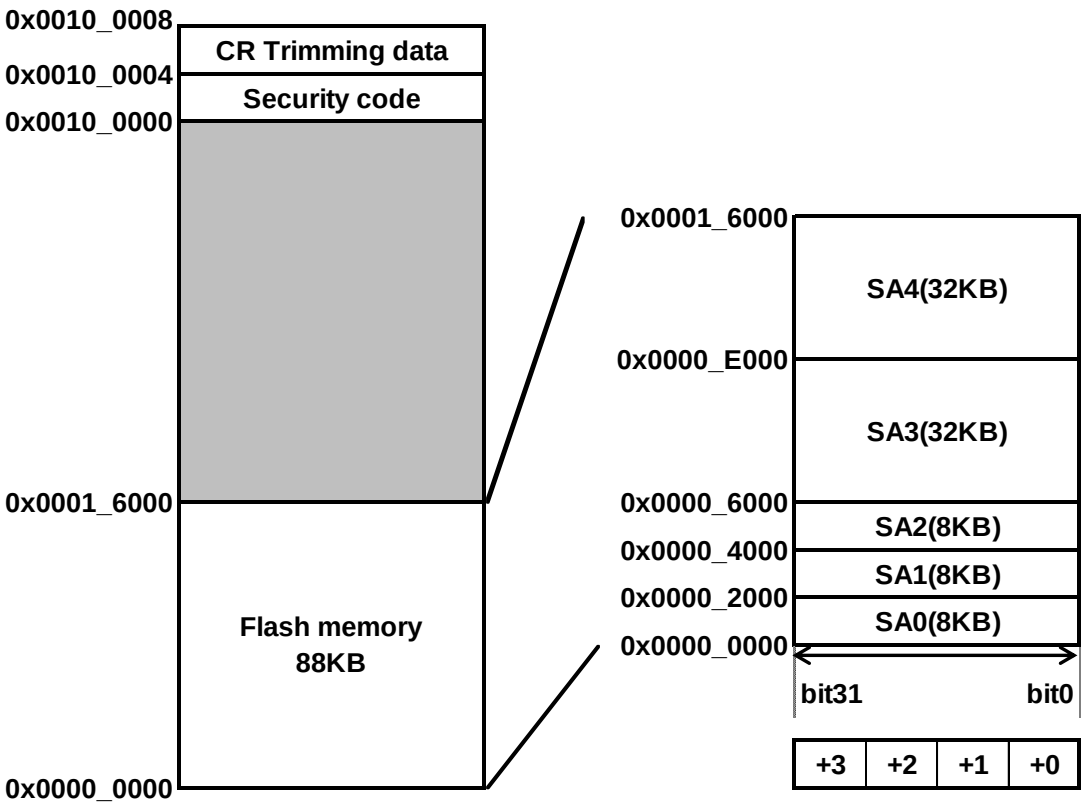


Figure 1-2. Address and sector structure of 56 Kbyte Flash memory

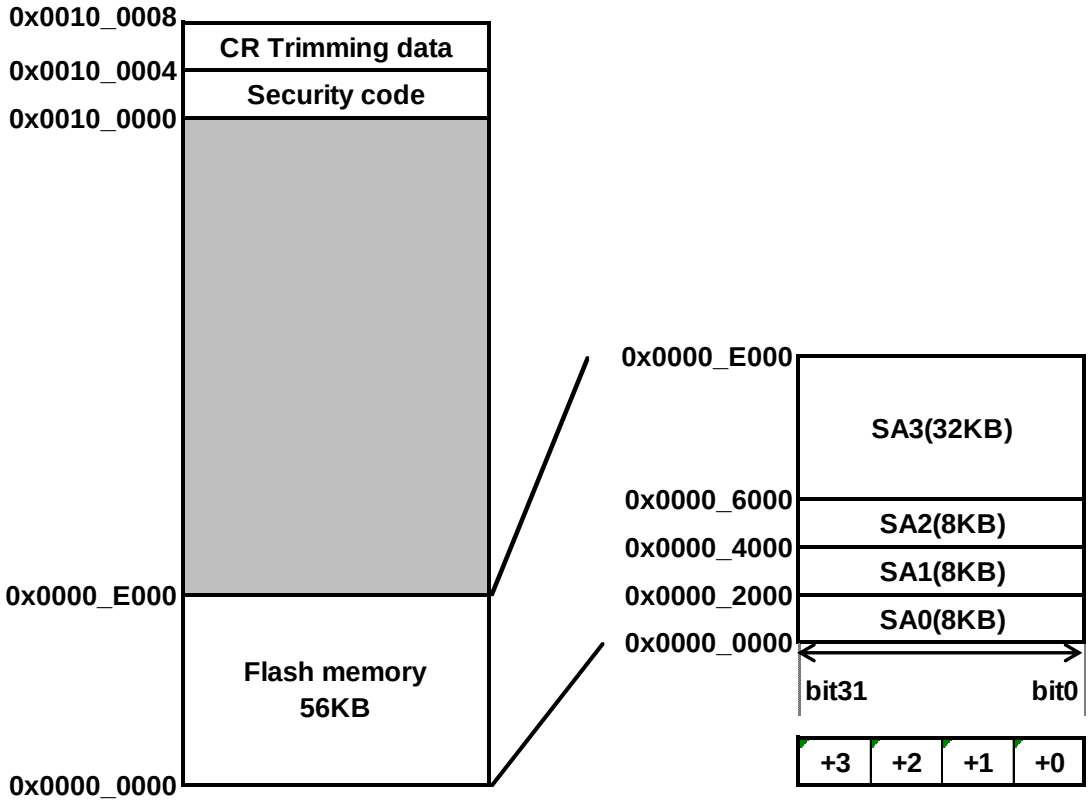


Figure 1-3. Address of security/CR trimming data

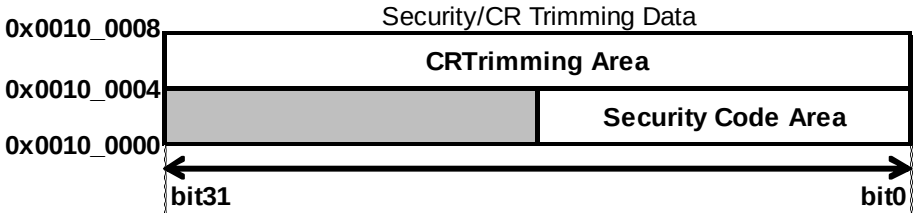


Figure 1-4. Bit configuration of CR trimming area

bit	31	21	20	16	15	10	9	0
Field	Reserved		CR temperature trimming data		Reserved		CR Frequency trimming data	

1.3 Operations

This section explains the Flash memory operation.

1.3.1 Automatic Algorithm
1.3.2 Flash Memory Operation
1.3.3 Cautions When Using Flash Memory

1.3.1 Automatic Algorithm

Writing to and erasing Flash memory is performed by activating the automatic algorithm.
This section explains the automatic algorithm.

1.3.1.1 Command Sequences

The automatic algorithm is activated by writing data to the Flash memory in the specified method. This is called a command. Table 1-2 shows the command sequences.

Table 1-2. Command sequence chart

Command	Number of writes	1st write		2nd write		3rd write		4th write		5th write		6th write	
		Address	Data	Address	Data	Address	Data	Address	Data	Address	Data	Address	Data
Read/ Reset	1	0xXXX	0xF0	--	--	--	--	--	--	--	--	--	--
Write	4	0xAA8	0xAA	0x554	0x55	0xAA8	0xA0	PA	PD	--	--	--	--
Flash erase	6						0x80	0xAA8	0xAA	0x554	0x55	0xAA8	0x10
Sector erase (No Sector added)	6											SA	0x30
Sector erase (Sector added)	6 and on												0xE0*
Sector erase suspended	1	0xXXX	0xB0	--	--	--	--	--	--	--	--	--	--
Sector erase restarting	1	0xXXX	0x30	--	--	--	--	--	--	--	--	--	--

X : Any address
PA : Write address
SA : Sector address (Specify any address of even number within the address range of the sector to be erased)
PD : Write data
*: To add sectors to be erased, repeat the 6th write operation for the required times. By writing 0x30 in the last sector address, the erase operation is started.

Notes:

- The data notation in Table 1-2 only shows the lower 8 bits. The upper 8 bits can be set to any value.
- Write commands in a byte (8 bits) or half-words (16 bits).
- The address notation in Table 1-2 only shows the lower 12 bits. The upper 20 bits should be set to any address within the address range of the target flash memory.

When the address outside the flash address range is specified, the command sequence would not be executed correctly since the flash memory cannot recognize the command.

- For Flash security code, write to 0x0010_0000 as PA.
- For CR Trimming data, write to 0x0010_0004 (CR Frequency Trimming Data) or 0x0010_0006 (CR Temperature Trimming Data) as PA.
- When any of 0x0010_0000, 0x0010_0004, 0x0010_0006 is assigned as SA, Flash Security Code and CR Trimming Data are erased thoroughly. Only any of them cannot be erased.

1.3.1.2 Command Operations

This section explains the command operations.
To execute the command operation program, store the program in RAM.

Read/reset command

The flash memory can be read and reset by sending the read/reset command.

When a read/reset command is issued, the flash memory maintains the read state until another command is issued.

When the execution of the automatic algorithm exceeds the time limit (HANG), the flash memory is returned to the read/reset state by issuing the read/reset command.

The read/reset command issued during each command operation is valid. In this case, commands previously issued are cleared. So, the commands issued should be issued again from the first command.

See Section "1.3.2.1 Read/Reset Operation" for details on the actual operation.

Program (write) command

The data is written in the address specified at the fourth time by issuing the write command to the target sector for four consecutive times. Data can be written in a byte (8 bits) or a half-word (16 bits) according to the data width specified at the fourth time. For the first to third commands, the data width is not judged.

Once the forth command issuance has finished, the automatic algorithm is activated and the automatic write to the flash memory starts. After executing the automatic write algorithm command sequence, there is no need to control the flash memory externally.

See Section "1.3.2.2 Write Operation" for details on the actual operation.

Note:

- Only a single byte or half-word of data can be written for each write command sequence.
  To write multiple pieces of data, issue one write command sequence for each piece of data.

Flash erase (all sector batch erase) command

All of the sectors in the flash memory can be batch-erased by sending the flash erase command in six consecutive writes. Once the sixth sequential write has finished, the automatic algorithm is activated and the flash erase operation starts.

Note:

- By flash erase command, the security/CR trimming data value can also be erased.

Sector erase command

By sending the sector erase command in six consecutive writes, the single sector specified by sixth write can be erased. When the sixth write data is "0x30", the automatic algorithm is activated and the sector erase operation begins.

To erase multiple sectors, issue the sector erase code (0xE0) which is the sixth write data. To erase more sectors, write the sector erase code, "0xE0" to sector address added in the seventh time and later. By writing the sector erase code, "0x30" in the last write data, the automatic algorithm is activated and the sector erase operation begins.

There is no restriction on number of sectors to be erased and all sectors can be erased collectively.

Note:

- The sector erase is started only by writing 0x30 to the sector erase command. 0xE0 cannot start the erase operation.

Sector erase suspended command

By issuing the sector erase suspended command during sector erase, sector erase can be suspended. In the sector erase suspended state, the read and write operations of memory cells of the sector not to erase is possible.
See Section "1.3.2.5 Sector Erase Suspended Operation" for details on the actual operation.

Notes:

- This command is only valid during sector erase. It is ignored even if it is issued during flash erase or during write.
- During the sector erase suspended state, the flash erase and the erase of sectors other than erase target sectors is not executed.

Sector erase restart command

In order to restart the erase operation in the sector erase suspended state, issue the sector erase restart command. Issuing the sector erase restart command returns the flash memory to the sector erase state and restarts the erase operation.
See Section "1.3.2.6 Sector Erase Restart Operation" for details on the actual operation.

Note:

- This command is only valid during sector erase suspended. It is ignored even if it is issued during sector erase.

1.3.1.3 Automatic Algorithm Run States

Writing and erasing of flash memory is performed by the automatic algorithm. Whether or not the automatic algorithm is currently executing can be checked by using the Flash Status Register (FSTR).

Flash Status Register

This indicates the status of the automatic algorithm. Table 1-2 shows the bit structure of the Flash Status Register.

Figure 1-5. Bit structure of the Flash Status Register

bit	7	6	5	4	3	2	1	0
Field	Reserved	Reserved	PGMS	SERS	ESPS	CERS	HNG	RDY

Note:

- Because the correct value might not be read out immediately after issuing a command, ignore the first value of the Flash Status Register that is read immediately after issuing a command.

- Status of each bit and Flash memory

For the correspondence between each bit of the Flash Status register and the status of the flash memory, see Table 1-3.

Table 1-3. List of each bit of Flash Status Flag Register

Parameter			PGMS	SERS	ESPS	CERS	HNG	RDY
Running	Program write operation		1	0	0	0	0	0
	Flash memory erase	Internal operation before erasing	0	0	0	0	0	0
		Erasing	0	0	0	1	0	0
	Sector erase		0	1	0	0	0	0
	Sector erase suspended	Program write operation (Sector not to erase)	1	1	1	0	0	0
		Other than above	0	1	1	0	0	1
Time limit exceeded	Program write operation		1	0	0	0	1	0
	Flash memory erase	Internal operation before erasing	0	0	0	0	1	0
		Erasing	0	0	0	1	1	0
	Sector erase		0	1	0	0	1	0
	Sector erase suspended	Program write operation (Sector not to erase)	1	1	1	0	1	0

(Note) See "■Bit descriptions" for the values that can be read.

- Bit descriptions

[bit7:6] Reserved bits

[bit5] PGMS: Program Write Operation Status flag bit

After issuing the Program Write Operation command, RDY bit becomes "0" and this bit is set to "1".
This bit of "1" means the Program Write Operation status.
After the Program Write Operation is finished, this bit is cleared to "0" and RDY bit becomes "1".

[bit4] SERS: Sector Erase Status flag bit

After issuing the Sector Erase command, RDY bit becomes "0" and this bit is set to "1".
This bit of "1" means the Sector Erase status.
After the Sector Erase Operation is finished, this bit is cleared to "0" and RDY bit becomes "1".

When the Sector Suspend command is issued during sector erasing, the erasing operation is suspended. During this suspended status, this bit continues to be "1".

[bit3] ESPS: Sector Erase Suspend Status flag bit

When the Sector Erase Suspend command is issued during sector erasing, the erasing operation is suspended, RDY bit becomes "1", and this bit is set to "1". This bit of "1" means the Sector Erase Suspend Status.
By issuing the Sector Erase Restart command, this bit is cleared to "0" and the Sector Erase Operation is restarted.
In the Sector Erase Suspend Status, the Program Write Operation command can be issued to the sectors not to erase. By issuing the command, the RDY bit is set to "0" and PGMS bit is set to "1" to transfer to "Program Write Operation status".

[bit2] CERS: Flash Memory Erase Status flag bit

When the Flash Erase command is issued, RDY bit becomes "0" and the Flash Memory is transferred to Pre-erasing Internal Operation Status. In this status, this bit is not set to "1" yet. After the Pre-erasing Internal Operation is completed, the Flash erasing is started and this bit is set to "1".
This bit of "1" means Flash Erasing Status.
After the Flash Erasing operation is completed, this bit is cleared to "0" and RDY bit becomes "1".

[bit1] HNG: HANG Status flag bit

The Internal Timer is mounted on the Flash Memory to provide the execution limit time of the Automatic Algorithm. When the Automatic Algorithm is not completed within the executing limit time specified by the internal timer, the Flash Memory becomes HANG Status and this bit is set to "1".

To clear this bit and to return to the normal status, it is required to generate the reset or to issue the reset command.

[bit0] RDY: RDY Status flag bit

This bit indicates whether the Automatic Algorithm is being executed or not. When the Flash Memory is being written or erased, this bit is set to "0" and the execution command cannot be accepted in this status. When this bit is "1", the execution command can be accepted (except the Sector Suspend command during sector erasing.)

1.3.2 Flash Memory Operation

The operation of the Flash memory is explained for each command.

1.3.2.1 Read/Reset Operation

This section explains the read/reset operation.

To place the flash memory in the read/reset state, send read/reset commands to an arbitrary address within the address range of the flash memory.

Because the read/reset state is the default state of the flash memory, the flash memory always returns to this state when the power is turned on or when a command finishes successfully. When the power is turned on, there is no need to issue a data read command. Furthermore, because data can be read by normal read access and programs can be accessed by the CPU while in the read/reset state, there is no need to issue read/reset commands.

1.3.2.2 Write Operation

This section explains the write operation.

Writes are performed according to the following procedure.

1. The program (write) command is issued sequentially.

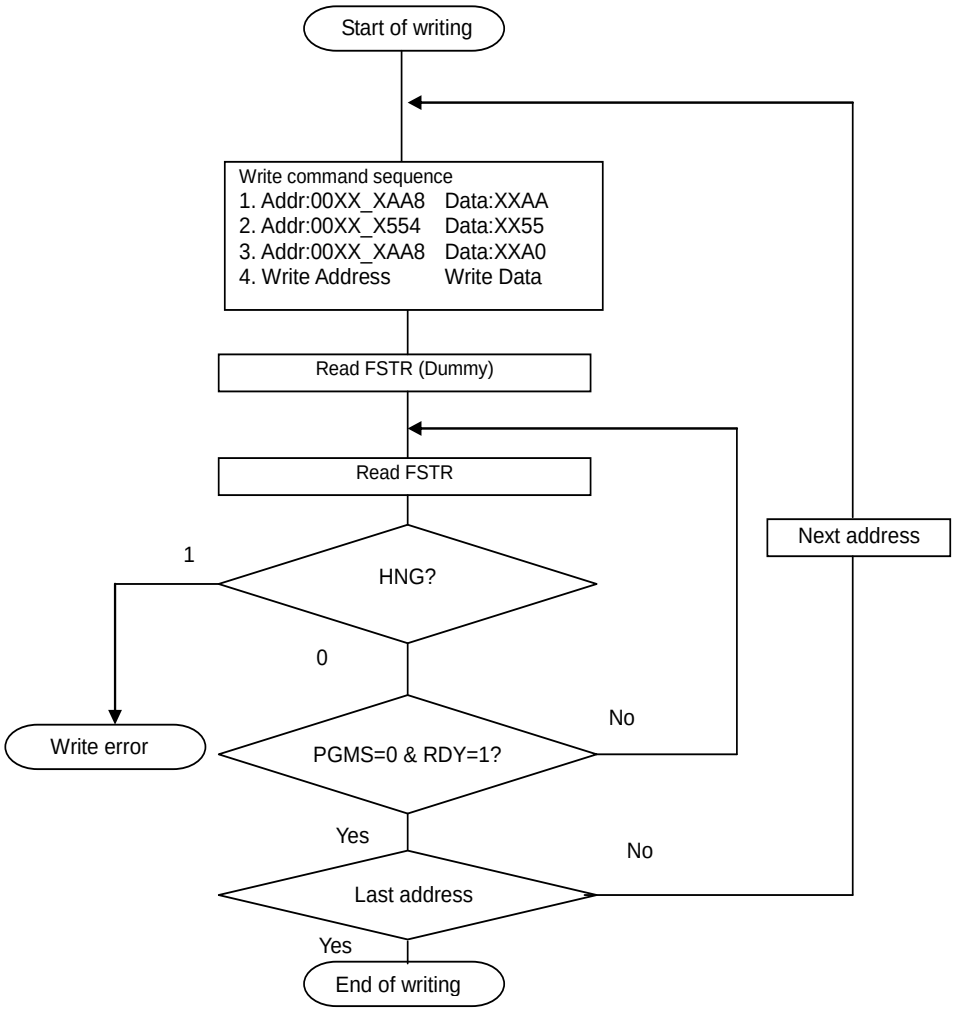
   The automatic algorithm activates and the data is written to the flash memory.
   After the write command is issued, there is no need to control the flash memory externally.

2. Confirm Flash Status Register (FSTR)

   After issuing the program write command, the RDY bit and PGMS bit of the Flash Status Register are set to "0" and "1" respectively. After the write operation is completed, the RDY bit and PGMS bit are set to "1" and "0" respectively.

See Figure 1-6 for an example of a write operation to the flash memory.

Figure 1-6. Example write operation



Notes:

- See Section "1.3.1 Automatic Algorithm" for details on the write command.
- Because the value of the flash memory might not read correctly immediately after the command issued, ignore the first read value of Flash Status Register (FSTR) after the command issued.
- Although the flash memory can be written in any sequence of addresses regardless of crossing sector boundaries, only a single byte or a single half-word of data can be written with each write command sequence. To write multiple pieces of data, issue one write command sequence for each piece of data.
- All commands issued to the flash memory during the write operation are ignored.
- If the device is reset while the write is in progress, the data that is written is not guaranteed.

1.3.2.3 Flash Erase Operation

This section explains the flash erase operation.

All sectors in flash memory can be erased in one batch. Erasing all of the sectors in one batch is called flash erase.

The automatic algorithm can be activated and all of the sectors can be erased in one batch by sending the flash erase command sequentially to the target sector.

See Section "1.3.1 Automatic Algorithm" for details on the flash erase command.

1. Issue the flash erase command sequentially

   The automatic algorithm is activated and the flash erase operation of the flash memory begins.

2. Confirm Flash Status Register (FSTR)

   After Flash Erase Command issued, the RDY bit of the Flash Status Register becomes "0". At this time, the flash memory becomes pre-erasing internal operation status and CERS bit is held to be "0". After erasing operation is started, the CERS bit is set to "1".
   After the flash erase is completed, the RDY bit and CERS bit are cleared to "1" and "0" respectively.

1.3.2.4 Sector Erase Operation

This section explains the sector erase operation.

Sectors in the flash memory can be selected and the data of only the selected sectors can be erased. Multiple sectors can be specified at the same time.

Sectors are erased according to the following sequence.

1. Issue the sector erase command sequentially to the target sector

   The automatic algorithm activates and the sector erase operation begins.

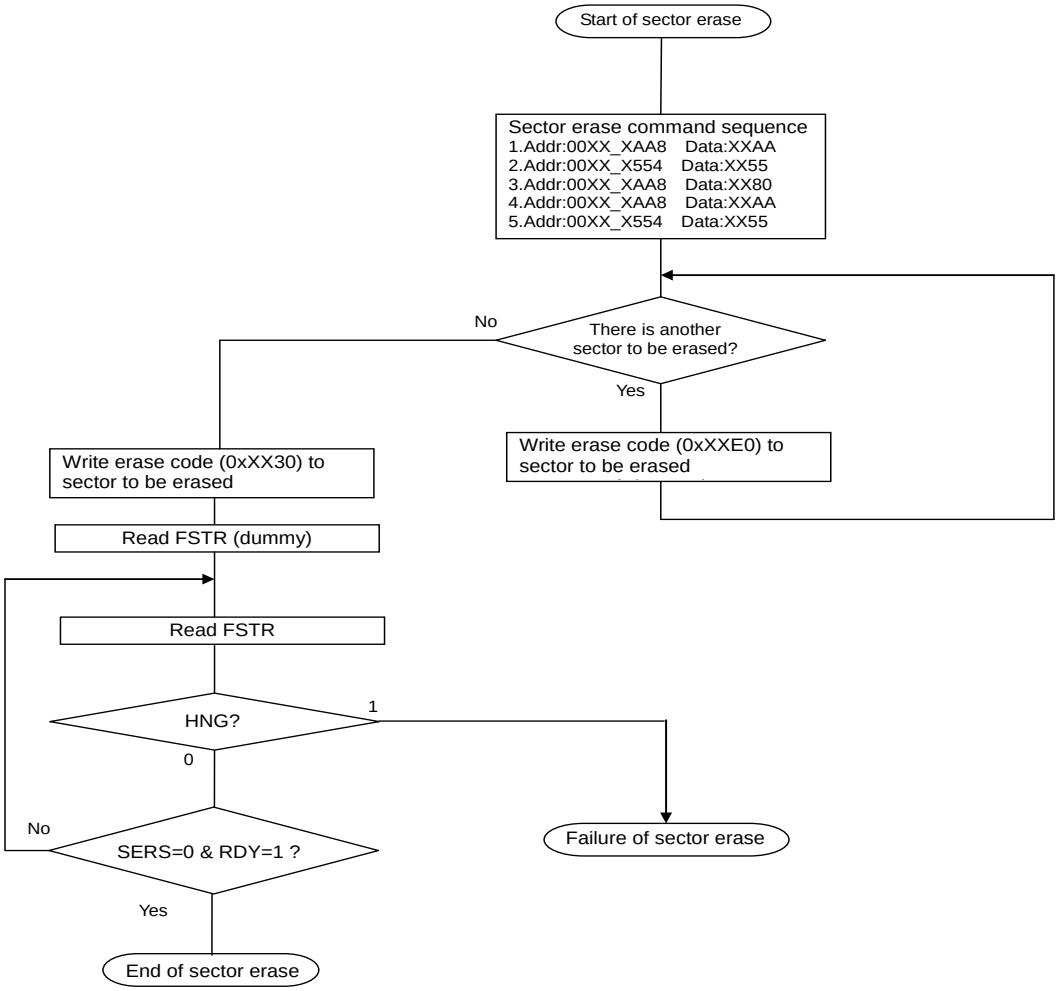
   To erase multiple sectors, write 0xE0 as the 6th write data (command data). By writing 0xE0 to the 7th sector address and later, sectors could be added to be erased. Write 0x30 in the last sector address, then the automatic algorithm is activated and the erase operation of multi sectors specified is started.
   There is no restriction on number of sectors added to be erased and all sectors can be erased collectively.

2. Confirm Flash Status Register (FSTR)

   After issuing Sector erase command, the RDY bit and SERS bit of the Flash Status Register are set to "0" and "1" respectively. After that, when the erase operation of all sectors specified are completed, the RDY bit and SERS bit are set to "1" and "0" respectively.

For an example of the sector erase procedure, see Figure 1-7.

Figure 1-7. Example of sector erase procedure



Once the sector erase operation has finished, the flash memory returns to read/reset mode.

Notes:

- See Section "1.3.1 Automatic Algorithm" for details on the sector erase command.
- Because the value may not be read correctly immediately after issuing a command, ignore the first read value of the Flash Status Register (FSTR) after issuing the command.

1.3.2.5 Sector Erase Suspended Operation

This section explains the sector erase suspended operation.

When the sector erase suspended command is sent during sector erase, the flash memory makes a transition to the sector erase suspended state and temporarily suspends the erase operation.
By sending the erase restart command, the flash memory is returned to the sector erase state and can restart the suspended erase operation.

Sector erase suspended operation

Sector erase is suspended in the following steps:

1. Write the sector erase suspended command to an address of even number within the address range of the flash memory during the erasing operation.
2. Confirm Flash Status Register (FSTR).

   Issuing the sector erase suspended command, the RDY bit and ESPS bit are set to "0" and "1" respectively. Under this condition, memory cells of a sector other than a sector to be erased are could be read and written.

Notes:

- See Section "1.3.1 Automatic Algorithm" for details on the sector erase suspended command.
- When a sector to be erased is read after a sector erase suspend, the value of the sector is undefined.

1.3.2.6 Sector Erase Restart Operation

This section explains the operation for restarting sector erase during sector erase suspended.

When the sector erase restart command is issued to any address of even number in the address range of the flash memory while sector erase is suspended, sector erase can be restarted.
When the sector erase restart command is issued, the sector erase operation during sector erase suspended is restarted.
See Section "1.3.1 Automatic Algorithm" for details on the sector erase restart command.

Note:

- The sector erase restart command is only valid during sector erase suspended. Even if the sector erase restart command is issued during sector erase, it is ignored.

1.3.3 Cautions When Using Flash Memory

This section explains the cautions when using the Flash memory.

- If this device is reset during the write, the data that is written cannot be guaranteed.
  Moreover, It is necessary to prevent an unexpected reset like Watchdog Timer from occurring during the writing and erasing.
- Immediately after issuing the automatic algorithm command to the flash memory, always perform a dummy read before reading the flash status register.
- If the device is forced to transfer to the low-power consumption mode, ensure the operations of the flash memory automatic algorithm is completed.
  See chapter "Low Power Consumption Mode" in "FM0+ Family Peripheral Manual" for details on the low-power consumption mode.

1.4 Registers

This section describes the registers of the flash memory.

List of registers of flash memory

Table 1-4 List of registers of flash memory

Abbreviation	Register Name	Reference
FRWTR	Flash Read Wait Register	1.4.1
FSTR	Flash Status Register	1.4.2
FICR	Flash Interrupt Control Register	1.4.3
FISR	Flash Interrupt Status Register	1.4.4
FICLR	Flash Interrupt Clear Register	1.4.5
CRTRMM	CR Trimming Data Mirror Register	1.4.6
FSYNDN	Flash Sync Down Register	1.4.7

1.4.1 Flash Read Wait Register (FRWTR)

The Flash Read Wait Register (FRWTR) specifies the wait cycle for the flash memory.

Register configuration

bit	7	6	5	4	3	2	1	0
Field	Reserved						RWT	
Attribute	-						R/W	
Initial Value	-						01	

Register functions

[bit7:2] Reserved bits

The read values are undefined. Ignored on write.

[bit1:0] Read Wait Cycle

Specifies the read wait cycle for the Flash Memory.

bit	Description
00	0 cycle wait mode This setting can be used when HCLK is 20MHz or less.
01	0 to 1 cycle wait mode (Initial value) This setting should be specified when HCLK is 20MHz or more.
10	Setting prohibited
11	Fixed wait cycle mode

Notes:

- When HCLK is more than 20MHz, the usage at the setting of RWT=00 is prohibited. At the setting of RWT=00, ensure that HCLK does not exceed 20MHz anytime.

- The wait cycle in fixed wait cycle mode is specified by FSYNDN register.

1.4.2 Flash Status Register (FSTR)

The Flash Status Register (FSTR) is a status register of the flash memory.

Register configurations

bit	7	6	5	4	3	2	1	0
Field	Reserved		PGMS	SERS	ESPS	CERS	HNG	RDY
Attribute	-		R	R	R	R	R	R
Initial Value	-		0	0	0	0	0	X

Register functions

[bit7:6] Reserved bits

The read values are undefined. Ignored on write.

[bit5] PGMS: Flash Program Status

Indicates the program (writing operation) status of the flash memory.

bit	Description
0	The program is not being written to the flash memory (Initial value)
1	The program is being written to the flash memory.

[bit4] SERS: Flash Sector Erase Status

Indicates the sector erase status of the flash memory.

bit	Description
0	The sector is not being erased. (Initial value)
1	The sector is being erased or the sector erase is being suspended.

[bit3] ESPS: Flash Erase Suspend Status

Indicates the sector erase suspend status of the flash memory.

bit	Description
0	The sector erase is not being suspended. (Initial value)
1	The sector erase is being suspended.

[bit2] CERS: Flash Chip Erase Status

Indicates the all sector erase status of the flash memory.

bit	Description
0	The flash memory is not being data erased. (Initial value)
1	The flash memory is being data erased.

[bit1] HNG: Flash Hang Status

Indicates whether the flash memory is in the HANG state. The flash memory enters the HANG state if the timing is exceeded.
If this bit becomes "1", issue a reset command (See section "1.3.1.1 Command Sequences").

bit	Description
0	The flash memory HANG state has not been detected. (Initial value)
1	The flash memory HANG state has been detected.

[bit0] RDY: Flash Ready Status

Indicates whether flash memory write or erase operation using the automatic algorithm is in progress or finished. While an operation is in progress, data cannot be written and the flash memory cannot be erased.

bit	Description
0	Operation in progress (cannot accept write/erase command)
1	Operation finished (can accept write/erase command)

1.4.3 Flash Interrupt Control Register (FICR)

The Flash Interrupt Control Register (FICR) specifies the interrupt enable setting of the flash memory.

Register configuration

bit	7	6	5	4	3	2	1	0
Field	Reserved						HANGIE	RDYIE
Attribute	-						R/W	R/W
Initial Value	-						0	0

Register functions

[bit7:2] Reserved bits

The read values are undefined. Ignored on write.

[bit1] HANGIE: HANG Interrupt Enable

This bit enables the flash HANG status interrupt. When the HANGIF bit in the FISR register and this bit are both "1", an interrupt to CPU is generated.

bit	Description
0	Flash HANG interrupt is prohibited. (Initial value)
1	Flash HANG interrupt is permitted.

[bit0] RDYIE: RDY Interrupt Enable

This bit enables the flash RDY status interrupt. When the RDYIF bit in the FISR register and this bit are both "1", an interrupt to CPU is generated.

bit	Description
0	Flash RDY interrupt is prohibited. (Initial value)
1	Flash RDY interrupt is permitted.

Note:

- Clear the corresponding bit in the FISR register before this bit is set to "1" to enable the interrupt.

1.4.4 Flash Interrupt Status Register (FISR)

The Flash Interrupt Status Register (FISR) indicates the interrupt status of the FLASH memory.

Register configuration

bit	7	6	5	4	3	2	1	0
Field	Reserved						HANGIF	RDYIF
Attribute	-						R/W	R/W
Initial Value	-						0	0

Register functions

[bit7:2] Reserved bits

The read values are undefined. Ignored on write.

[bit1] HANGIF: HANG Interrupt Flag

This bit is set to "1" when the Flash HANG status is detected. This bit is set to "1" with the rising edge of HANG signal. This bit is cleared to be "0" by writing "1" to the HANGC bit in the FICLR register.

bit	Description
0	Flash HANG status is not detected. (Initial value)
1	Flash HANG status is detected.

[bit0] RDYIF: RDY Interrupt Flag

This bit is set to "1" when the Flash RDY status is detected. This bit is set to "1" with the rising edge of RDY signal. This bit is cleared to be "0" by writing "1" to the RDYC bit in the FICLR register.

bit	Description
0	Flash RDY status is not detected. (Initial value)
1	Flash RDY status is detected.

1.4.5 Flash Interrupt Clear Register (FICLR)

The Flash Interrupt Clear Register (FICLR) clears the interrupt flag of flash memory.

Register configuration

bit	7	6	5	4	3	2	1	0
Field	Reserved						HANGC	RDYC
Attribute	-						W	W
Initial Value	-						0	0

Register functions

[bit7:2] Reserved bits

The read values are undefined. Ignored on write.

[bit1] HANGC: HANG Interrupt Clear

This bit is the clear bit of HANG interrupt flag. This bit clears the HANGIF bit in the FISR register to "0" by writing "1" to this bit.

The read value is always "0".

bit	Description
0	The flash HANG interrupt flag (HANGIF) is not changed. (Initial value)
1	The flash HANG interrupt flag (HANGIF) is cleared to be "0".

[bit0] RDYC: RDY Interrupt Flag

This bit is the clear bit of RDY interrupt flag. This bit clears the RDYIF bit in the FISR register to "0" by writing "1" to this bit.

The read value is always "0".

bit	Description
0	The flash RDY interrupt flag (RDYIF) is not changed. (Initial value)
1	The flash RDY interrupt flag (RDYIF) is cleared to be "0".

1.4.6 CR Trimming Data Mirror Register (CRTRMM)

The CR Trimming Data Mirror Register (CRTRMM) is the mirror register of the CR trimming data.
A value of this register can be used in the user mode and the serial writer mode.

Register configuration

bit	31	21	20	16	15	10	9	0
Field	Reserved		TTRMM		Reserved		TRMM	
Attribute	-		R		-		R	
Initial Value	-		*1		-		*2	

*1: Value of bit[4:0] at the address 0x0010_0006

*2: Value of bit[9:0] at the address 0x0010_0004

Register functions

[bit31:21] Reserved bits

The read values are undefined. Ignored on write.

[bit20:16] TTRMM : CR Temperature Trimming Data Mirror Bit

After a reset is released, bit[4:0](CR Temperature Trimming Data) at the address "0x0010_0006" in Flash Memory area are stored in this bit.
For details of High-speed CR Trimming data, see chapter "High-speed CR Trimming Data" in "FM0+ Family Peripheral Manual".

[bit15:10] Reserved bits

The read values are undefined. Ignored on write.

[bit9:0] TRMM : CR Trimming Data Mirror Bit

After a reset is released, bit[9:0](CR Frequency Trimming Data) at the address "0x0010_0004" in Flash Memory area are stored in this bit.
For details of High-speed CR Trimming data, see chapter "High-speed CR Trimming Data" in "FM0+ Family Peripheral Manual".

Note:

- After erasing the flash memory data and issuing "Reset" signal inside the chip, this register is cleared. At this time, the stored CR trimming data is deleted. So, save the stored CR trimming data to RAM etc. before this register is cleared.

1.4.7 Flash Sync Down Register (FSYNDN)

The wait cycle is inserted in the read access to the flash memory. Current consumption can be reduced by decreasing the access clock frequency of the flash memory.

Register configuration

bit	7	6	5	4	3	2	1	0
Field	Reserved				SD			
Attribute	-				R/W			
Initial Value	-				0001			

Register functions

[bit7:4] Reserved bits

The read values are undefined. Ignored on write.

[bit3:0] SD : Sync Down

Specifies the wait cycle inserted in the read access of the flash memory.

Bit	Description
0000	Setting prohibited
0001	1 wait cycle (Initial value)
0010	Setting prohibited
0011	3 wait cycles
0100	Setting prohibited
0101	5 wait cycles
0110	Setting prohibited
0111	7 wait cycles
1000	Setting prohibited
1001	9 wait cycles
1010	Setting prohibited
1011	11 wait cycles
1100	Setting prohibited
1101	13 wait cycles
1110	Setting prohibited
1111	15 wait cycles

Notes:

- The register is valid only when RWT bits in FRWTR register is set to "11". Otherwise the value of this register is ignored.

2. Flash Security

The flash security function protects contents of the flash memory.

This chapter explains the overview and operations of the flash security.

0. Overview

2.1 . Operation ExplanationOverview

This section explains the overview of the flash security.

If the protection code of 0x0001 is written in the security code area of the flash memory, access to the flash memory is restricted. Once the flash memories are protected, the protection cannot be released until a flash erase operation is performed. This function is suitable for applications requiring security of self-containing program and data stored in the flash memory.

Table 2-1 shows the address and the protection code of the security code.

Table 2-1. Address of security code and protection code

Address	Protection Code
0x0010_0000	0x0001

2.1 Operation Explanation

This section explains the operation of the flash security.

Setting Security

Write the protection code 0x0001 in address of the security code. The security is enabled and set after all the reset factors are generated or after turning on the power again.

Releasing Security

The security is released by all the reset factors or power-on after the execution of flash erase.

Operation with Security Enabled

The operations with security enabled vary depending on each mode.

Table 2-2 shows the security operations in each mode.

Table 2-2. Flash Operation with Security Enabled

Mode	Mode pin MD0	Access to flash			Access from debugging pin
		Flash erase	Other commands	Read	
User mode	0	Enabled	Enabled	Valid data	Disabled
Serial writer mode	1	Enabled	Disabled	Invalid data	Disabled

Notes:

- Writing the protection code is generally recommended to take place at the end of the flash programming. This is to avoid unnecessary protection during the programming.
- In user mode, there is no limit to the flash memory even during security is enabled. However, debugging pins are fixed not to access internally from these pins during security is enabled. To release security, perform the flash erase operation using a serial writer because the security cannot be released through debugging pins.
- When security enabled, the obstruction analysis of the flash memory cannot be performed.

3. Serial Programming Connection

This series supports serial on-board programming to the flash memory. This chapter explains the basic configuration for serial programming to the flash memory by using the Cypress Serial Programmer.

3.1 . Serial Programmer

3.1 Serial Programmer

Cypress Serial Programmer (software) is an on-board programming tool for all microcontrollers with built-in flash memory.

This serial programmer supports RS-232C interface.

3.1.1 Basic Configuration

This section explains the basic configuration.

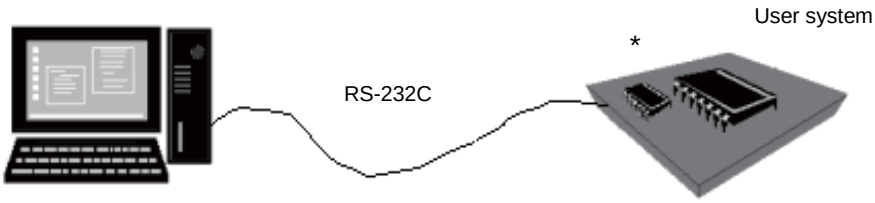
Basic Configuration of CYPRESS MCU Programmer (Clock Asynchronous Serial Programming)

CYPRESS MCU Programmer writes data, through clock asynchronous serial communication, to built-in flash memory of a microcontroller installed in the user system when the PC and the user system are connected through RS-232C cable.

In this series, serial programming (UART communication mode) is possible by any clock, crystal oscillator or external clock or built-in High-speed CR oscillator.

Figure 3-1 shows the basic configuration of CYPRESS MCU Programmer, and Table 3-1 lists the system configuration.

Figure 3-1. Basic Configuration of CYPRESS MCU Programmer



* RS-232C driver IC is required separately.

Table 3-1. System Configuration of CYPRESS MCU Programmer

Name	Specifications
CYPRESS MCU Programmer	Software (In case you request the data, contact to sales representatives.)
RS-232C cable	Sold on the market.

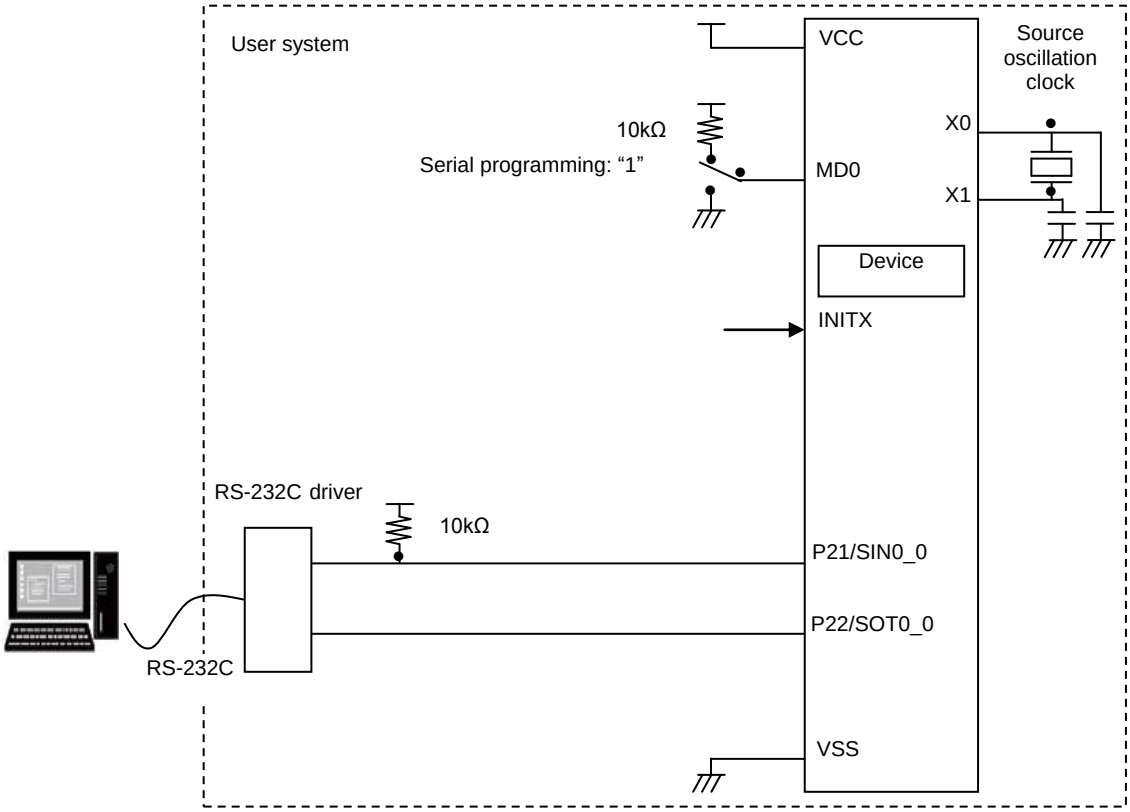
Connection Example of CYPRESS MCU Programmer

The following shows a connection example of CYPRESS MCU Programmer.

- When Crystal oscillator is used as the source oscillation clock

Figure 3-2 shows a connection example of CYPRESS MCU Programmer when a crystal oscillator is used as a source oscillation clock and Table 3-2 available frequencies and communication baud rates.

Figure 3-2. Connection Example when Crystal Oscillator is used



Note: The pull-up resistor values shown are for example.
Select the most appropriate resistor values for each system.

Table 3-2. Oscillating frequency and communication baud rate available for clock asynchronous serial communication

Source Oscillating Frequency	Communication Baud Rate
4MHz	9600bps
8MHz	19200bps
16MHz	38400bps
24MHz	57600bps

- When built-in high-speed CR oscillator is used as a source oscillation clock

Figure 3-3 shows a connection example of CYPRESS MCU Programmer when a built-in high-speed CR oscillator is used as a source oscillation clock.

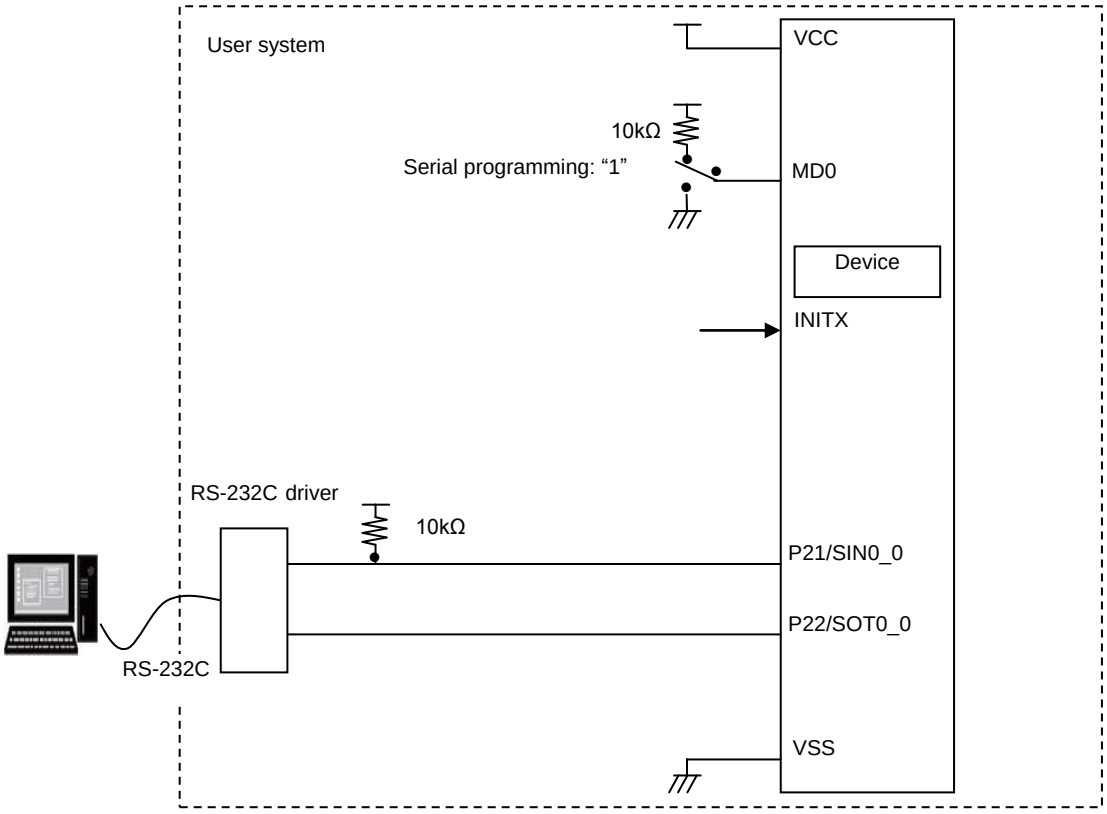
When neither crystal oscillator nor external clock is connected to X0/X1 pins, the built-in high-speed CR oscillator is connected for communication.

The communication baud rate is 9600[bps] when built-in high-speed CR oscillator is used

The following are the restrictions when built-in high-speed CR oscillator is used

- Because the oscillation frequency of the built-in high-speed CR oscillator would fluctuate due to temperature and voltage change, the allowable baud rate error range might be exceeded. Keep the baud rate within the allowed error range.
- For using the built-in high-speed CR oscillator, see "Built-in CR Oscillation Specifications" in "Data Sheet" of the product used.

Figure 3-3. Connection Example When Built-in High-speed CR Oscillator is used



Note: The pull-up resistor values shown are for example.
Select the most appropriate resistor values for each system.

3.1.2 Pins Used

This section explains the used pins

Table 3-3. Pins used for serial programming

Pins	Function	Supplement
MD0	Mode pin	Performing an external reset or turning on the power after setting MD0=H enters the serial programming mode. When attaching a pull-up or pull-down resistor, avoid long wiring.
X0, X1	Oscillation pin	See the "Data Sheet" of a product used for the source oscillation clock (main clock) frequencies that can be used in serial programming mode. (Restrictions apply to clock asynchronous communication. For details, see Table 3-2) In UART communication mode, the write operation is available without main clock.
P22/SOT0_0	UART serial data output pin	When the communication mode is set to UART, this pin becomes a serial data output pin when communication begins after the serial programming mode is activated.
P21/SIN0_0	Clock synchronous/ asynchronous select pin/UART serial data input pin	Setting the input level of this pin to "H" until the start of communication enables the clock asynchronous communication mode, and setting it to "L" enables the clock synchronous communication mode. When the communication mode is set to UART, this pin can be used as a serial data input pin when communication begins after the serial programming mode is activated.
INITX	Reset pin	-
VCC	Power supply pin	For writing, supply power to the microcontroller from the user system.
VSS	GND pin	-

Revision History

Document Revision History

Document Title: FM0+ Family S6E1A1 Series, Flash Programming Guide Document Number: 002-05028			
Revision	**Issue Date**	**Origin of Change**	**Description of Change**
**	01/17/2014	TOYO	Initial release
*A	01/27/2016	TOYO	Migrated Spansion Guide from S6E1A1_MN710-00005-1v0-E to Cypress format